

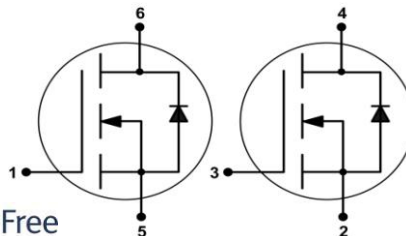
OptiMOS™2 Small-Signal-Transistor

Features

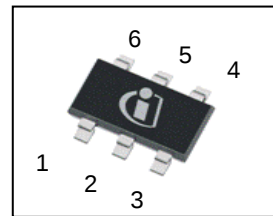
- Dual N-channel
- Enhancement mode
- Logic level (4.5V rated)
- Avalanche rated
- Qualified according to AEC Q101
- 100% lead-free; RoHS compliant
- Halogen free according to IEC61249-2-21



Halogen-Free



PG-TSOP-6



Type	Package	Tape and Reel Information	Marking	Lead Free	Packing
BSL306N	TSOP-6	H6327: 3000 pcs/ reel	sPN	Yes	Non dry

Maximum ratings, at $T_j=25\text{ °C}$, unless otherwise specified ¹⁾

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I_D	$T_A=25\text{ °C}$	2.3	A
		$T_A=70\text{ °C}$	1.8	
Pulsed drain current	$I_{D,pulse}$	$T_A=25\text{ °C}$	9	
Avalanche energy, single pulse	E_{AS}	$I_D=2.3\text{ A}$, $R_{GS}=25\text{ }\Omega$	10.8	mJ
Reverse diode dv/dt	dv/dt	$I_D=2.3\text{ A}$, $V_{DS}=16\text{ V}$, $di/dt=200\text{ A}/\mu\text{s}$, $T_{j,max}=150\text{ °C}$	6	kV/ μs
Gate source voltage	V_{GS}		± 20	V
Power dissipation ¹⁾	P_{tot}	$T_A=25\text{ °C}$	0.5	W
Operating and storage temperature	T_j , T_{stg}		-55 ... 150	°C
ESD Class		JESD22-A114 -HBM	0 (<250V)	
Soldering Temperature			260 °C	
IEC climatic category; DIN IEC 68-1			55/150/56	

¹⁾ Remark: one of both transistors active

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

Thermal characteristics

Thermal resistance, junction - ambient	R_{thJA}	minimal footprint ²⁾	-	-	250	K/W
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Electrical characteristics, at $T_j=25\text{ °C}$, unless otherwise specified
Static characteristics

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{ V}, I_D=250\text{ }\mu\text{A}$	30	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=11\text{ }\mu\text{A}$	1.2	1.60	2.0	
Drain-source leakage current	I_{DSS}	$V_{DS}=30\text{ V}, V_{GS}=0\text{ V}, T_j=25\text{ °C}$	-	-	1	μA
		$V_{DS}=30\text{ V}, V_{GS}=0\text{ V}, T_j=150\text{ °C}$	-	-	100	
Gate-source leakage current	I_{GSS}	$V_{GS}=20\text{ V}, V_{DS}=0\text{ V}$	-	-	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=4.5\text{ V}, I_D=1.85\text{ A}$	-	66	93	$\text{m}\Omega$
		$V_{GS}=10\text{ V}, I_D=2.3\text{ A}$	-	43	57	
Transconductance	g_{fs}	$ V_{DS} >2 I_D R_{DS(on)max}, I_D=1.8\text{ A}$		5	-	S

²⁾ Performed on 40mm² FR4 PCB. The traces are 1mm wide, 70 μm thick and 20mm long; they are present on both sides of the PCB.

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

Dynamic characteristics

Input capacitance	C_{iss}	$V_{GS}=0\text{ V}, V_{DS}=15\text{ V},$ $f=1\text{ MHz}$	-	207	275	pF
Output capacitance	C_{oss}		-	75	100	
Reverse transfer capacitance	C_{rss}		-	12	17	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=15\text{ V}, V_{GS}=10\text{ V},$ $I_D=2.3\text{ A}, R_{G,ext}=6\text{ }\Omega$	-	4.4	-	ns
Rise time	t_r		-	2.3	-	
Turn-off delay time	$t_{d(off)}$		-	8.3	-	
Fall time	t_f		-	1.4	-	

Gate Charge Characteristics

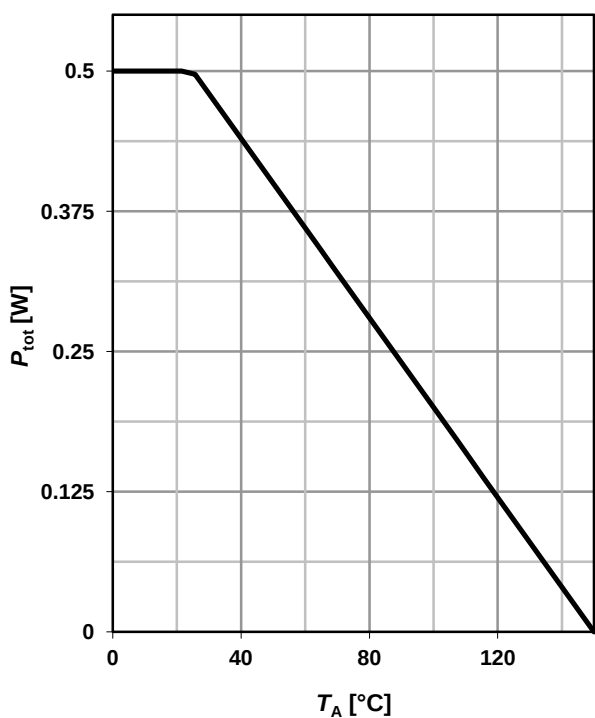
Gate to source charge	Q_{gs}	$V_{DD}=15\text{ V}, I_D=2.3\text{ A},$ $V_{GS}=0\text{ to }5\text{ V}$	-	0.65	-	nC
Gate to drain charge	Q_{gd}		-	0.45	-	
Gate charge total	Q_g		-	1.6	-	
Gate plateau voltage	$V_{plateau}$		-	3.1	-	V

Reverse Diode

Diode continuous forward current	I_S	$T_A=25\text{ }^\circ\text{C}$	-	-	0.5	A
Diode pulse current	$I_{S,pulse}$		-	-	9	
Diode forward voltage	V_{SD}	$V_{GS}=0\text{ V}, I_F=2.3\text{ A},$ $T_j=25\text{ }^\circ\text{C}$	-	0.83	1.1	V
Reverse recovery time	t_{rr}	$V_R=10\text{ V}, I_F=2.3\text{ A},$ $di_F/dt=100\text{ A}/\mu\text{s}$	-	14.4	-	ns
Reverse recovery charge	Q_{rr}		-	2.9	-	nC

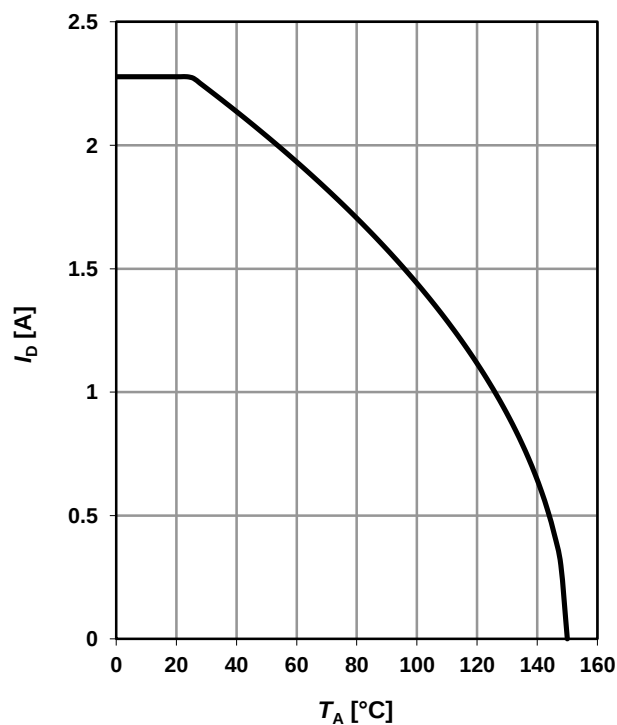
1 Power dissipation

$$P_{\text{tot}} = f(T_A)$$



2 Drain current

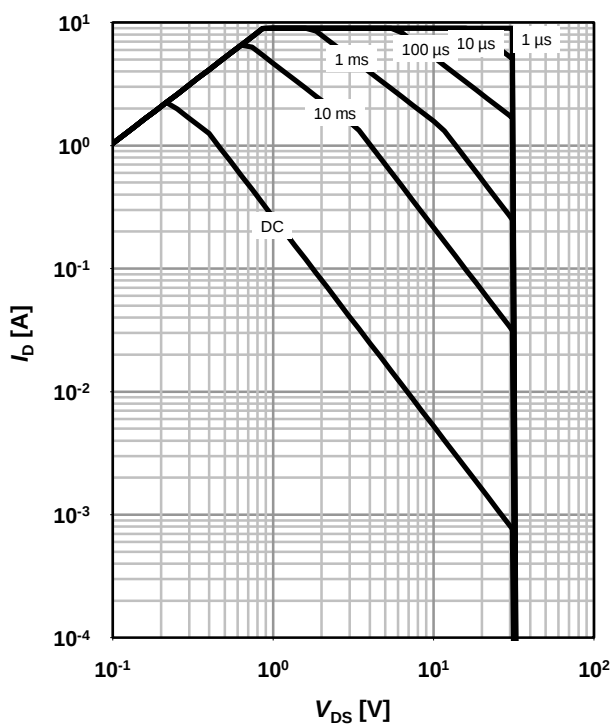
$$I_D = f(T_A); V_{GS} \geq 10 \text{ V}$$



3 Safe operating area

$$I_D = f(V_{DS}); T_A = 25^\circ\text{C}; D = 0$$

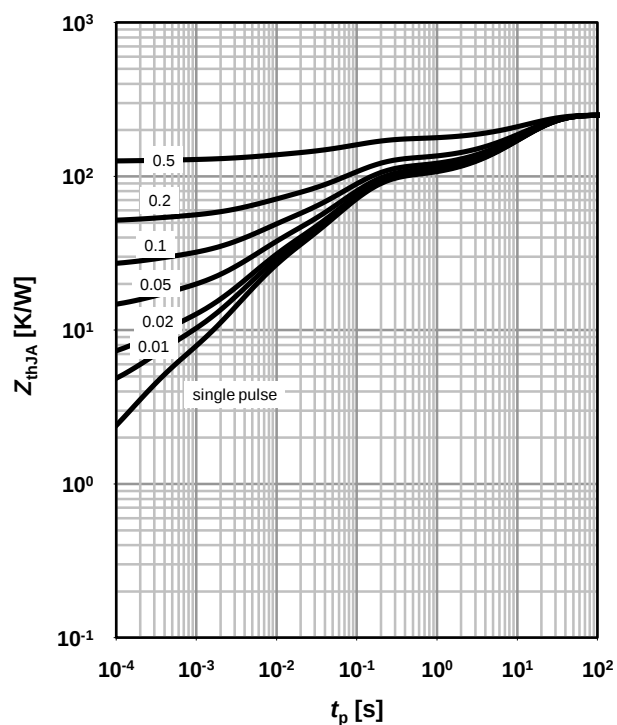
parameter: t_p



4 Max. transient thermal impedance

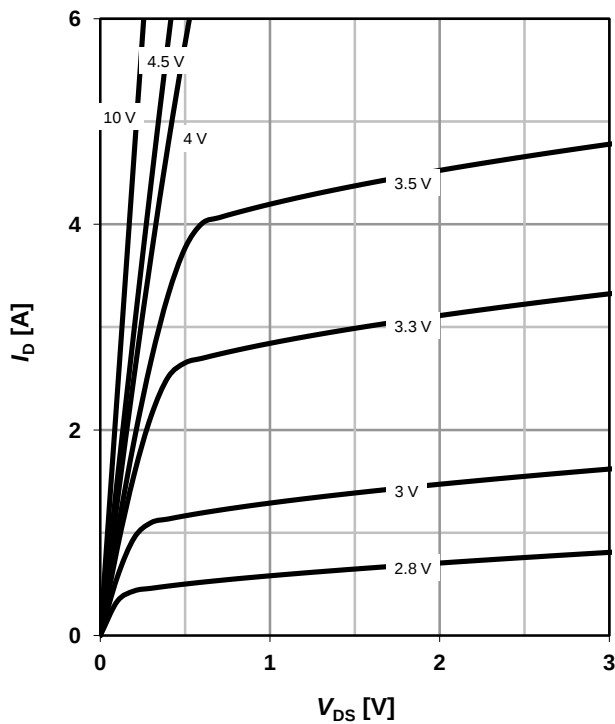
$$Z_{thJA} = f(t_p)$$

parameter: $D = t_p/T$



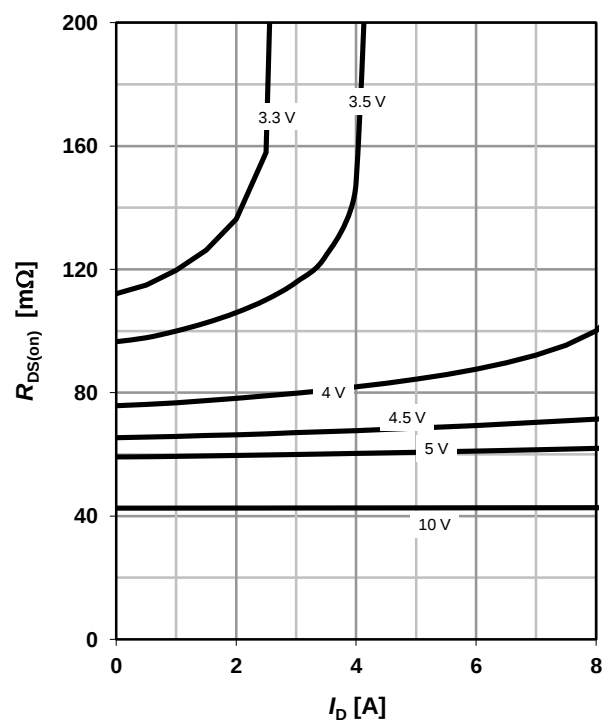
5 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25^\circ\text{C}$

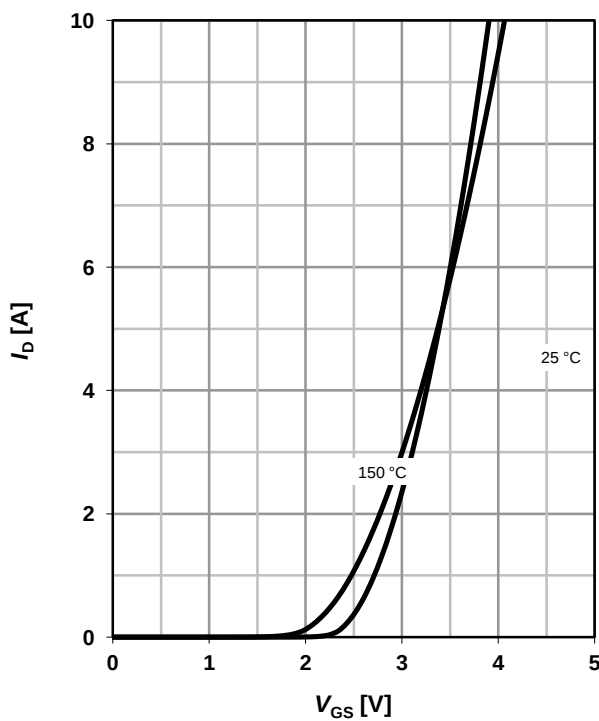
parameter: V_{GS}


6 Typ. drain-source on resistance

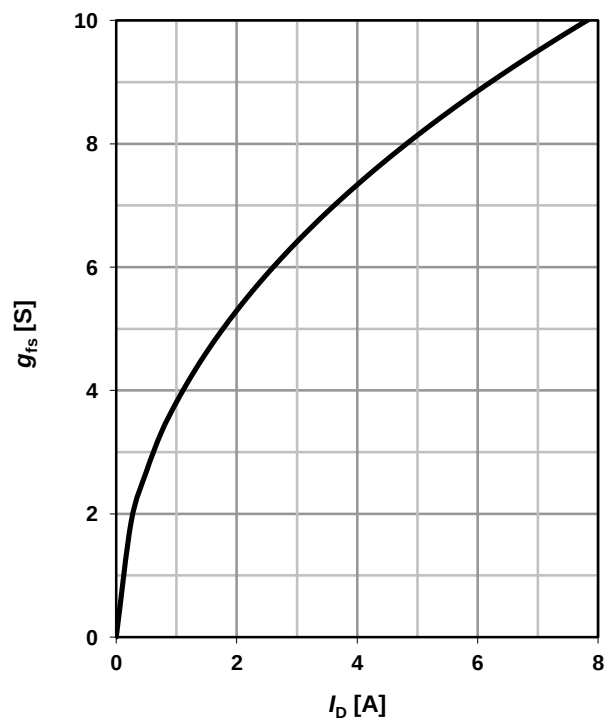
 $R_{DS(on)} = f(I_D); T_j = 25^\circ\text{C}$

parameter: V_{GS}


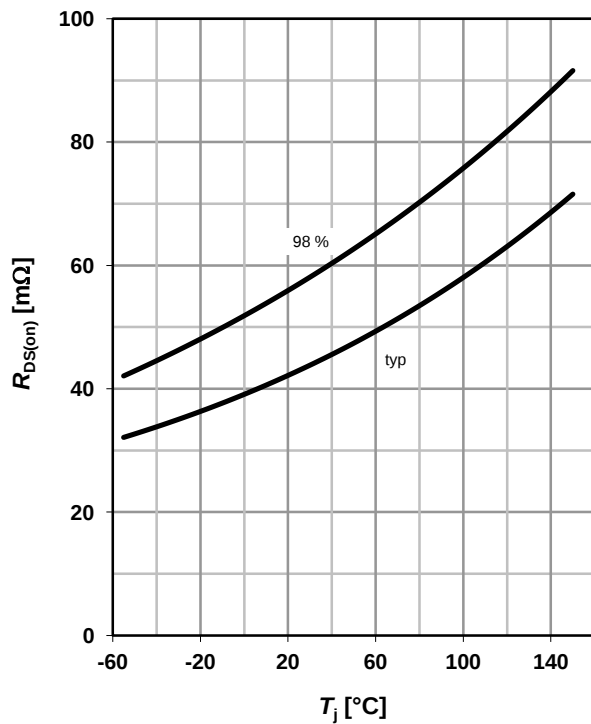
7 Typ. transfer characteristics

 $I_D = f(V_{GS}); |V_{DS}| > 2|I_D|R_{DS(on)max}$


8 Typ. forward transconductance

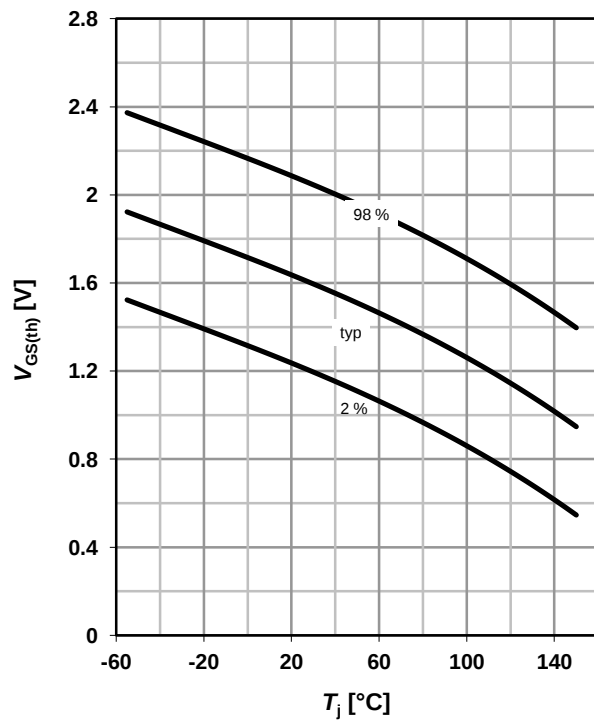
 $g_{fs} = f(I_D); T_j = 25^\circ\text{C}$


9 Drain-source on-state resistance

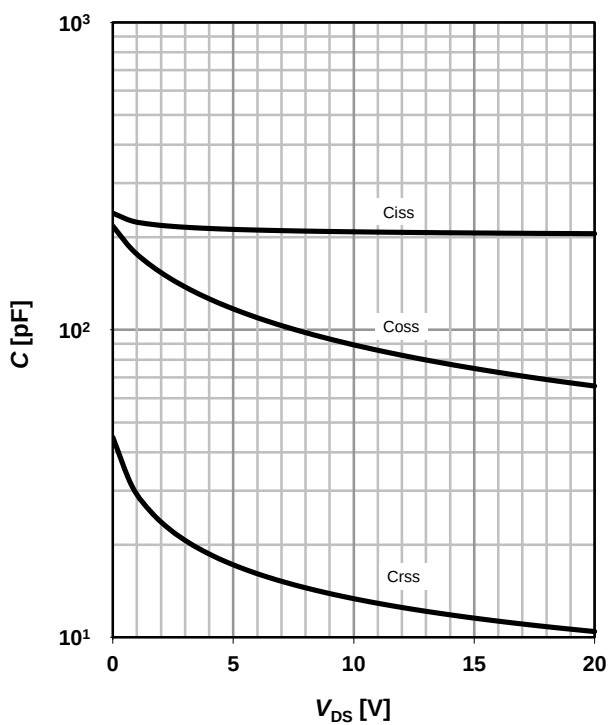
 $R_{DS(on)} = f(T_j); I_D = 2.3 \text{ A}; V_{GS} = 10 \text{ V}$


10 Typ. gate threshold voltage

 $V_{GS(th)} = f(T_j); V_{DS} = V_{GS}; I_D = 11 \mu\text{A}$

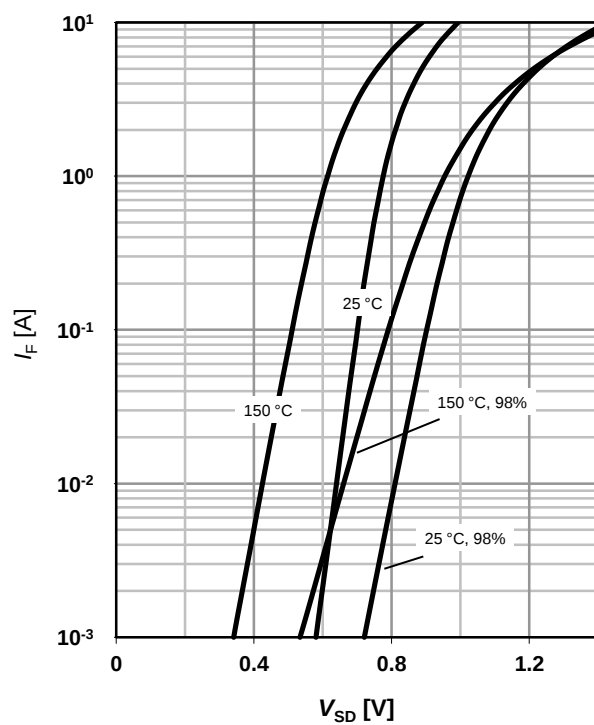
parameter: I_D


11 Typ. capacitances

 $C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}; T_j = 25^\circ\text{C}$


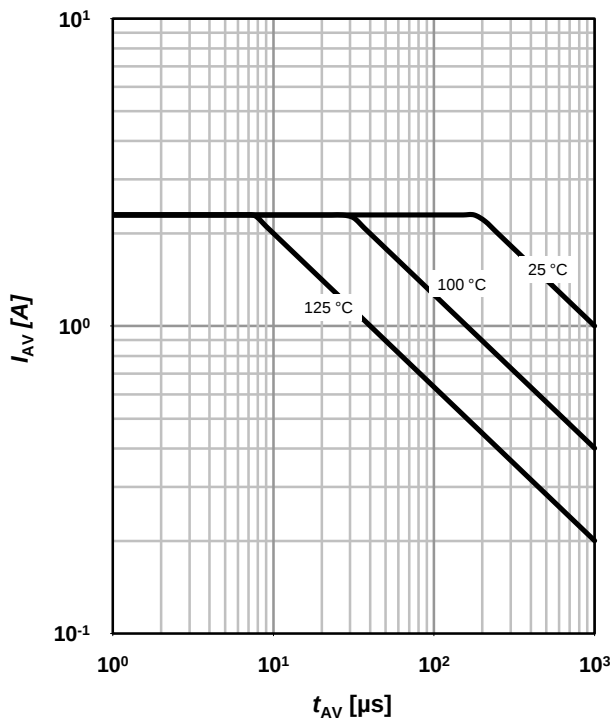
12 Forward characteristics of reverse diode

 $I_F = f(V_{SD})$

parameter: T_j


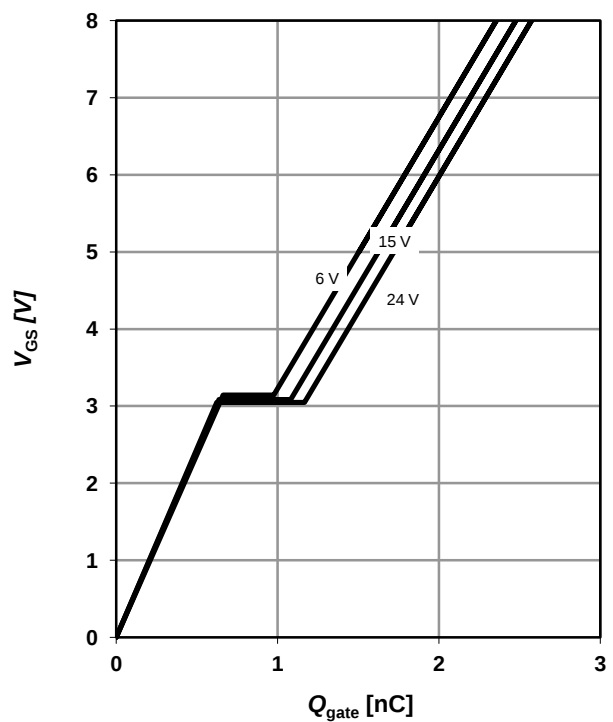
13 Avalanche characteristics

 $I_{AS}=f(t_{AV}); R_{GS}=25\ \Omega$

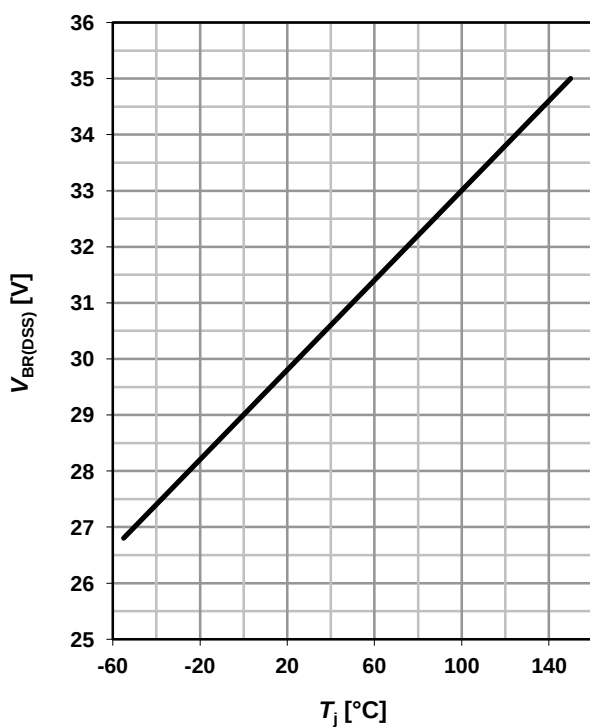
parameter: $T_{j(\text{start})}$


14 Typ. gate charge

 $V_{GS}=f(Q_{\text{gate}}); I_D=2.3\ \text{A pulsed}$

parameter: V_{DD}


15 Drain-source breakdown voltage

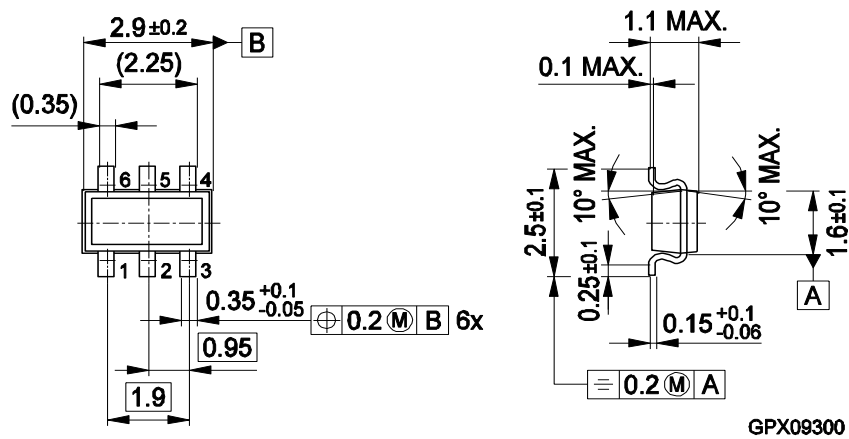
 $V_{BR(DSS)}=f(T_j); I_D=250\ \mu\text{A}$


16 Gate charge waveforms

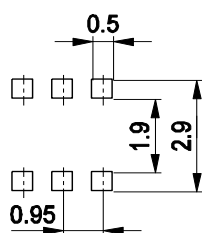


TSOP-6

Package Outline:



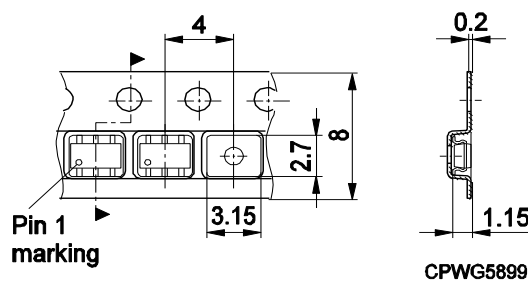
Footprint:



Remark: Wave soldering possible dep.
on customers process conditions

HLG09283

Packaging:



CPWG5899

Dimensions in mm

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